

Description

The SWF20N65 can be used in various power swithching circuit for system miniaturization and higher efficiency.The package form is TO-220/ TO-220F, which accords with the RoHS standard.

General Features

 $V_{DS} = 650V, I_D = 20A$ $R_{DS(ON)} < 0.3 \Omega@ V_{GS} = 10V$

Application

• Power switch circuit of adaptor and charger.

Package Marking and Ordering Information

Product ID	Pack	Marking	Units Tube
SWF20N65	TO-220F	20N65 XXX YYYY	50

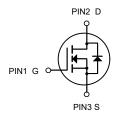
Absolute Maximum Ratings@T =25°C(unless otherwise specified)

Symbol	Parameter	Lmit	Unit	
V _{DSS}	Drain-to-Source Voltage ^[1]	650	V	
V _{GSS}	Gate-to-Source Voltage	±30		
ID	Continuous Drain Current	20		
I _{D@Tc=100} ℃	Continuous Drain Current @ Tc=100℃	13	А	
I _{DM}	Pulsed Drain Current at V _{GS} =10V ^[2]	80		
E _{AS}	Single Pulse Avalanche Energy	980	mJ	
P _D	Power Dissipation	32	W	
T _L T _{PAK}	Maximum Temperature for Soldering Leads at 0.063in (1.6mm) from Case for 10 seconds, Package Body for 10 seconds	300 260	°C	
T _J & T _{STG}	Operating and Storage Temperature Range	-55 to 150		
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case	3.9	°C AA/	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	55	°C /W	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.



TO-220F



N-Channel MOSFET



Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0V$	650	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650 V, V_{GS} = 0 V$	-	-	1.0	μA
I_{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 30V$	-	-	±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	3	4	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽⁴⁾	$V_{GS} = 10V, I_{D} = 10A$	-	0.4	0.47	Ω
$\mathbf{C}_{\mathrm{iss}}$	Input Capacitance		-	3234	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 25V,$ f = 1MHz	-	266	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 11/11/2	-	34	-	pF
Q_g	Total Gate Charge	N/ 0/ /0//	-	73	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 520V, I_{D} = 20A$	-	17	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V DS = 020 V, ID = 20/V	-	29	-	nC
t _{d(on)}	Turn-On DelayTime		-	45	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 330V	-	64	-	ns
t _{d(off)}	Turn-Off DelayTime	I_D = 20A, R_{GEN} = 24 Ω	-	218	-	ns
t _f	Turn-Off Fall Time		-	84	-	ns
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	20	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	80	А
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	494	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 20A, di/dt = 100A/us	-	7.9	-	μC

Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise specified

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

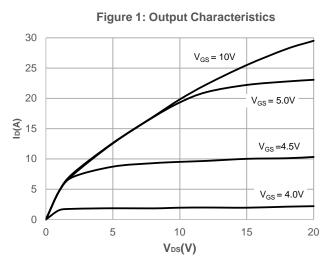
2. E_{AS} condition: Starting T_J=25C, V_{DD}=50V, V_G=10V, R_G=25ohm, L=10mH, I_{AS}=14A

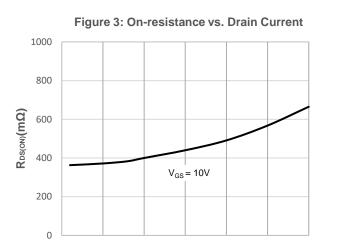
3. $R_{\theta JA}$ is measured with the device mounted on a minimum recommended pad of 2oz copper FR4 PCB

4. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.



Typical Characteristics





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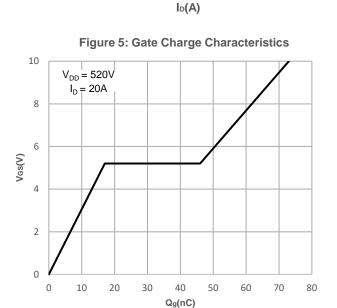
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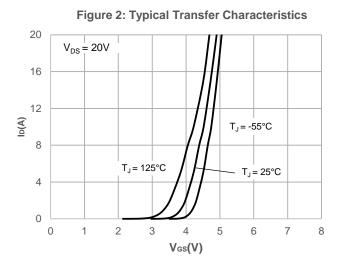
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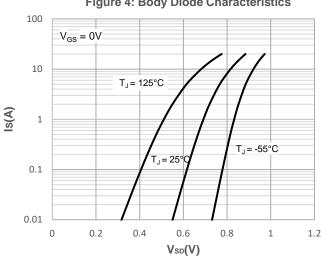
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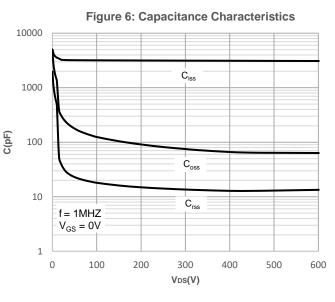
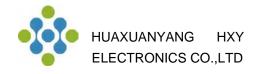


Figure 4: Body Diode Characteristics



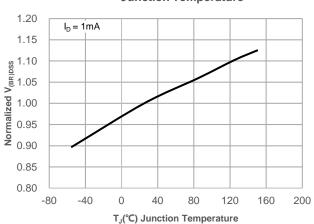
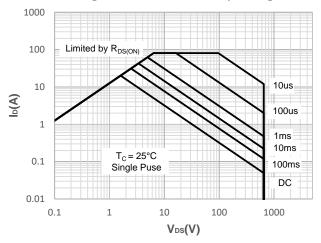
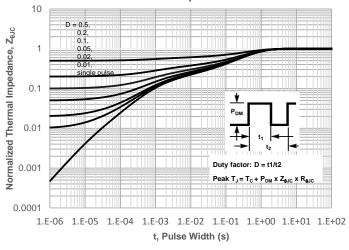


Figure 7: Normalized Breakdown voltage vs. Junction Temperature









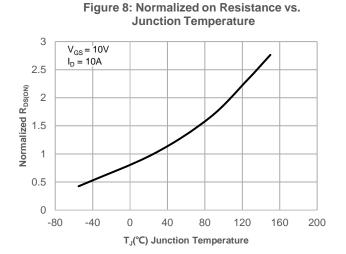
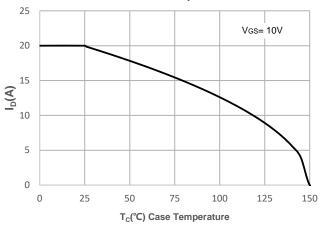
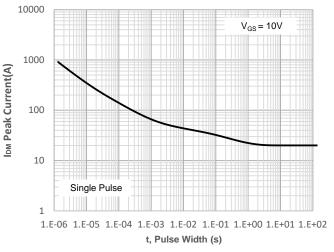


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

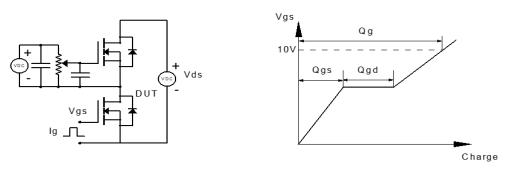








Test Circuit





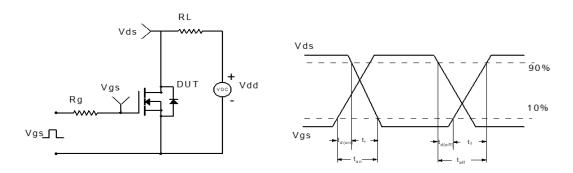


Figure 2: Resistive Switching Test Circuit & Waveform

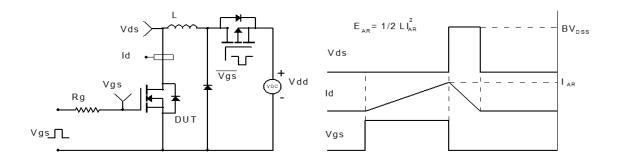
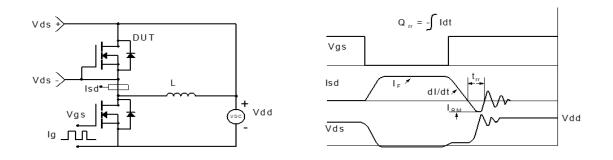


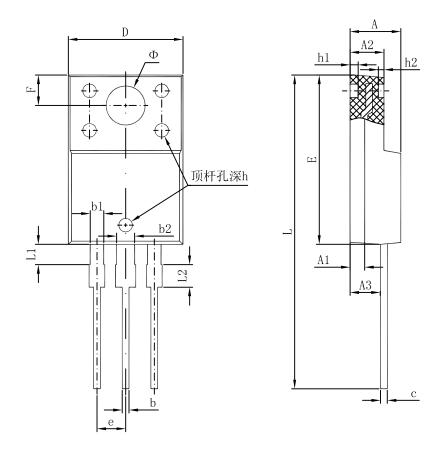
Figure 3: Unclamped Inductive Switching Test Circuit& Waveform



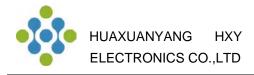




Package Dimension TO-220F



Symphol	Dimensions In Millimeters		Dimensions In Inches			
Symbol	Min.	Max.	Min.	Max.		
A	4.300	4.700	0.169	0.185		
A1	1.300	REF.	0.051	0.051 REF.		
A2	2.800	3.200	0.110	0.126		
A3	2.500	2.900	0.098	0.114		
b	0.500	0.750	0.020	0.030		
b1	1.100	1.350	0.043	0.053		
b2	1.500	1.750	0.059	0.069		
С	0.500	0.750	0.020	0.030		
D	9.960	10.360	0.392	0.408		
E	14.800	15.200	0.583	0.598		
е	2.540 TYP.		0.100 TYP.			
F	2.700	2.700 REF. 0.106 REF.		REF.		
Φ	3.500 REF.		0.138 REF.			
h	0.000	0.300	0.000	0.012		
h1	0.800 REF.		0.031 REF.			
h2	0.500 REF.		0.020 REF.			
L	28.000	28.400	1.102	1.118		
L1	1.700	1.900	0.067	0.075		
L2	1.900	2.100	0.075	0.083		



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